



## Surface Mount Ultrafast Rectifier



DO-214AC (SMA)

### FEATURES

- Low profile package
- Ideal for automated placement
- Glass passivated chip junction
- Ultrafast reverse recovery time
- Low switching losses, high efficiency
- High forward surge capability
- Meets MSL level 1, per J-STD-020, LF maximum peak of 260 °C
- Compliant to RoHS Directive 2002/95/EC and in accordance to WEEE 2002/96/EC
- **Halogen-free according to IEC 61249-2-21 definition**



**RoHS**  
COMPLIANT  
HALOGEN  
**FREE**

### PRIMARY CHARACTERISTICS

$I_{F(AV)}$	1.0 A
$V_{RRM}$	50 V to 1000 V
$I_{FSM}$	30 A
$t_{rr}$	50 ns, 75 ns
$V_F$	1.0 V, 1.7 V
$T_J \text{ max.}$	150 °C

### TYPICAL APPLICATIONS

For use in high frequency rectification and freewheeling application in switching mode converters and inverters for consumer, computer, and telecommunication.

### MECHANICAL DATA

**Case:** DO-214AC (SMA)

Molding compound meets UL 94 V-0 flammability rating  
Base P/N-M3 - halogen-free, RoHS compliant, and commercial grade

**Terminals:** Matte tin plated leads, solderable per J-STD-002 and JESD 22-B102

M3 suffix meets JESD 201 class 1A whisker test

**Polarity:** Color band denotes cathode end

### MAXIMUM RATINGS ( $T_A = 25\text{ °C}$ unless otherwise noted)

PARAMETER	SYMBOL	US1A	US1B	US1D	US1G	US1J	US1K	US1M	UNIT
Device marking code		UA	UB	UD	UG	UJ	UK	UM	
Maximum repetitive peak reverse voltage	$V_{RRM}$	50	100	200	400	600	800	1000	V
Maximum RMS voltage	$V_{RMS}$	35	70	140	280	420	560	700	V
Maximum DC blocking voltage	$V_{DC}$	50	100	200	400	600	800	1000	V
Maximum average forward rectified current at $T_L = 110\text{ °C}$	$I_{F(AV)}$	1.0							A
Peak forward surge current 8.3 ms single half sine-wave superimposed on rated load	$I_{FSM}$	30							A
Operating and storage temperature range	$T_J, T_{STG}$	- 55 to + 150							°C

# US1A thru US1M

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ELECTRICAL CHARACTERISTICS (T <sub>A</sub> = 25 °C unless otherwise noted)											
PARAMETER	TEST CONDITIONS	SYMBOL	US1A	US1B	US1D	US1G	US1J	US1K	US1M	UNIT	
Maximum instantaneous forward voltage	1.0 A	V <sub>F</sub> <sup>(1)</sup>	1.0				1.7				V
Maximum DC reverse current at rated DC blocking voltage	T <sub>A</sub> = 25 °C	I <sub>R</sub>	10								μA
	T <sub>A</sub> = 100 °C		50								
Maximum reverse recovery time	I <sub>F</sub> = 0.5 A, I <sub>R</sub> = 1.0 A, I <sub>rr</sub> = 0.25 A	t <sub>rr</sub>	50				75				ns
Typical junction capacitance	4.0 V, 1 MHz	C <sub>J</sub>	15				10				pF

**Note**

(1) Pulse test: 300 μs pulse width, 1 % duty cycle

THERMAL CHARACTERISTICS (T <sub>A</sub> = 25 °C unless otherwise noted)										
PARAMETER	SYMBOL	US1A	US1B	US1D	US1G	US1J	US1K	US1M	UNIT	
Maximum thermal resistance	R <sub>θJA</sub> <sup>(1)</sup>	75								°C/W
	R <sub>θJL</sub> <sup>(1)</sup>	27								

**Note**

(1) PCB mounted on 0.2" x 0.2" (5.0 mm x 5.0 mm) copper pad area

ORDERING INFORMATION (Example)				
PREFERRED P/N	UNIT WEIGHT (g)	PREFERRED PACKAGE CODE	BASE QUANTITY	DELIVERY MODE
US1J-M3/61T	0.064	61T	1800	7" diameter plastic tape and reel
US1J-M3/5AT	0.064	5AT	7500	13" diameter plastic tape and reel

## RATINGS AND CHARACTERISTICS CURVES

(T<sub>A</sub> = 25 °C unless otherwise noted)

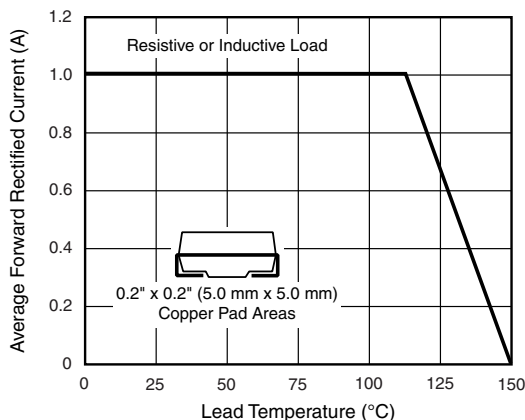


Fig. 1 - Forward Current Derating Curve

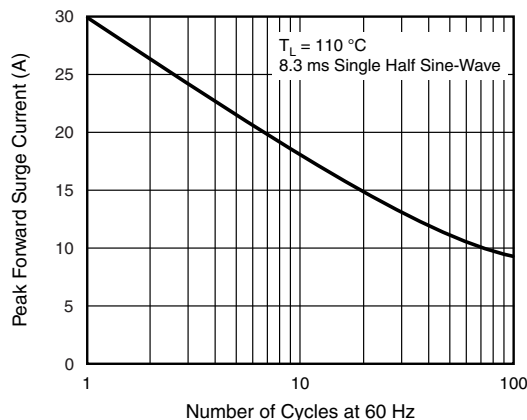


Fig. 2 - Maximum Non-Repetitive Peak Forward Surge Current

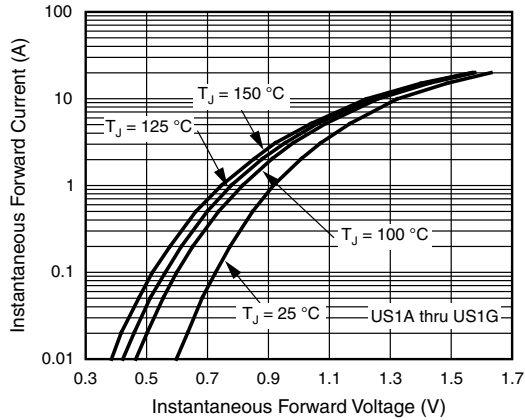


Fig. 3 - Typical Instantaneous Forward Characteristics

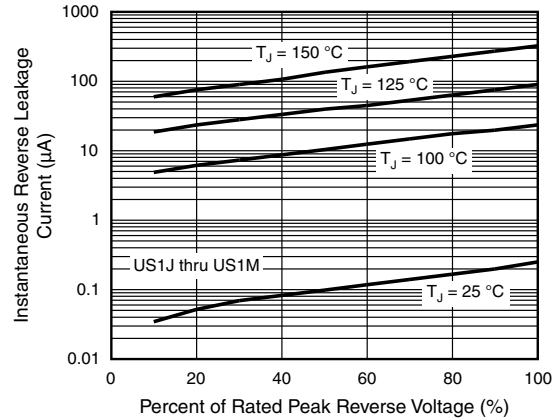


Fig. 6 - Typical Reverse Leakage Characteristics

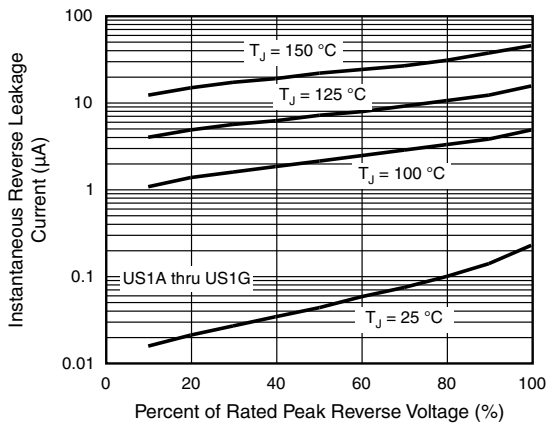


Fig. 4 - Typical Reverse Leakage Characteristics

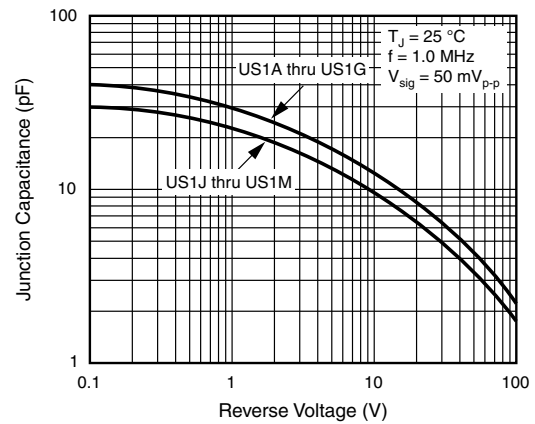


Fig. 7 - Typical Junction Capacitance

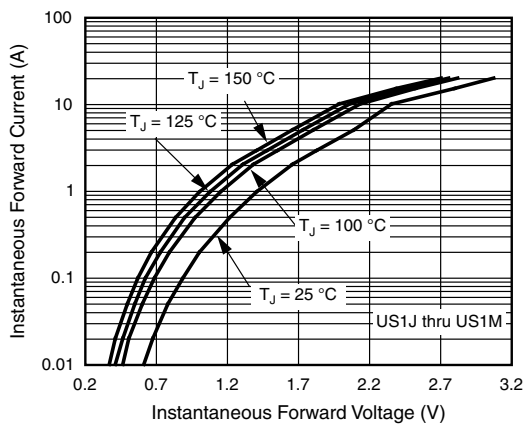


Fig. 5 - Typical Instantaneous Forward Characteristics

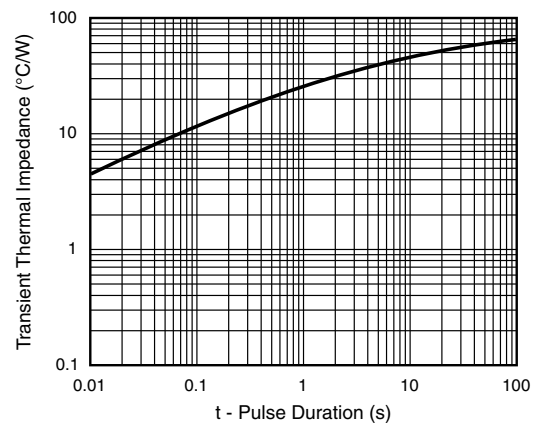


Fig. 8 - Typical Transient Thermal Impedance

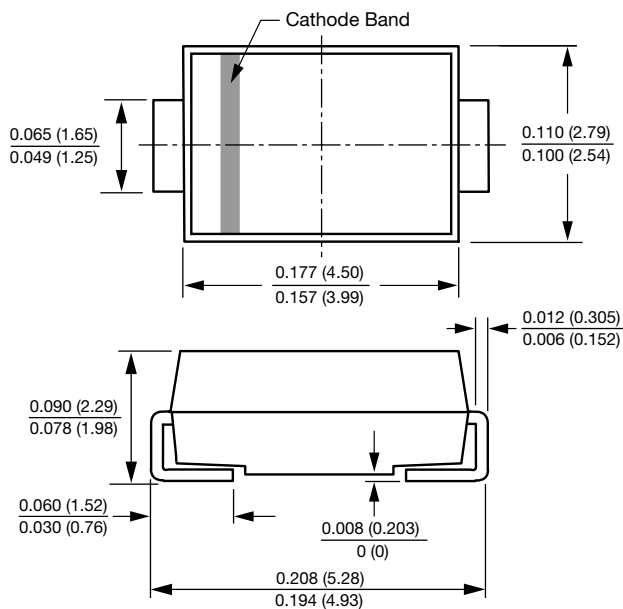
# US1A thru US1M

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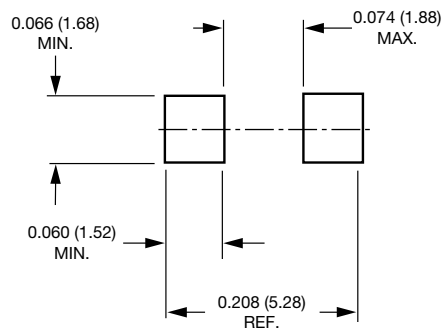


## PACKAGE OUTLINE DIMENSIONS in inches (millimeters)

### DO-214AC (SMA)



### Mounting Pad Layout





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